

VACUUM CHAMBER PM TECHNIQUE AMAT 5500 TXZ CHAMBER

OBJECTIVE:

TO EFFECTIVELY PM THE AMAT 5500 TxZ IN A TIMELY MANNER, WHILE IMPROVING TOOL RECOVERY AND PARTICLE PERFORMANCE

<u>Vacuum Chamber</u>: AMAT

<u>Vacuum Chamber Process Residue</u>: FILM FROM CVD DEPOSITION OF TD MAT <u>Vacuum Chamber Components</u>: CHAMBER, EXIT AND ENTRY PORTS

Old Method: Cleanroom wipers and ScotchBrite® with H₂O₂

Note: Use of H₂O₂ causes a variety of environmental, health, and safety concerns. It can cause prolonged

pump down times.

Solvent: DI water, IPA

Vacuum Chamber Products:

- (1) HT4754 UltraSOLV® Sponge
- (1) <u>HT4536DS</u>-10 **OR** <u>HT4536D</u>-10 360 Grit Diamond ScrubPAD, (slit optional)
- (1) <u>HT4560S</u>-10 **OR** <u>HT4560</u>-10 600 Grit Diamond ScrubPAD, (slit optional)

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- (1) <u>HT4513PDS</u>-10 1350 Grit Diamond ScrubPAD **OR** (1) <u>HT4512PS</u> 1200 Grit Diamond ScrubPAD
- (20-25) HT4790 or HT4794 UltraSOLV® Wipers
- (20-25) HT1700 UltraSOLV® Swabs
- (10) <u>HT1701</u> UltraSOLV® Swabs
- (25-50) <u>HT1702</u> UltraSOLV[®] Swabs
- (10-15) HT1714 UltraSOLV® Swabs
- A container that can hold a minimum of 1 liter of DI water

AMAT 5500 TxZ Chamber PM Procedure:

View "How to" instructional videos on http://www.foamtecintlwcc.com/video/

Step 1: Vacuum inside of the chamber

Step 2: Keep fluid from the heater well by stuffing the area with 3-4 <u>balled-up HT4790</u> or <u>HT4794</u> wipers

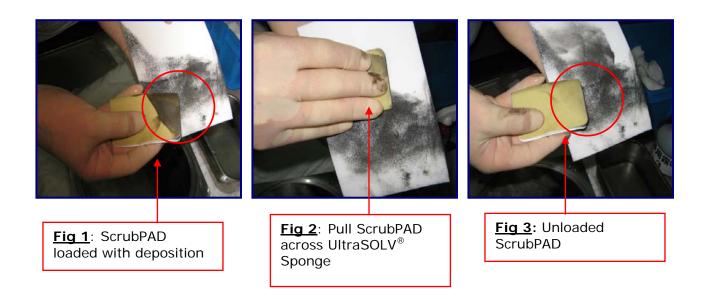
Step 3: Wipe the inside of the chamber using an H₂O dampened <u>HT4754</u> sponge

Step 4: Use several DI dampened <u>HT4790</u> or <u>HT4794</u> wipers to line the inside of the slit valve and pump port

NOTE: Dampen wipers by immersing them repeatedly in a container of DI water and squeezing them while submersed to make sure they are thoroughly wet. It is critical to thoroughly squeeze the water from the wipers before rolling and inserting them into the slit valve and pump port

Step 5: Alternate between scouring the chamber with the <u>HT4560</u>-10 or the <u>HT4560S</u>-10 (slitted) ScrubPAD and remove abrasion build-up with sponge

Step 6: To clear ScrubPAD of sludge, wipe the pad lightly in one direction, with an <a href="https://example.com/https://exa



AMAT 5500 TxZ CHAMBER PM PROCEDURE (CONT'D):

Step 7: Unload UltraSOLV® as much as possible by placing it in container of DI water and RINSE-OUT thoroughly (See Fig 4 & 5)



Fig 4: Loaded-up UltraSOLV[®] Sponge

<u>Fig 5</u>: UltraSOLV[®] Sponge AFTER rinse



- **Step 8:** Use the <u>HT4512PS</u>-10 ScrubPAD to clean the chamber lid and the opposing sealing surface in the same manner. Do not scrub the showerhead if left in place during the clean. Use the <u>HT4513PDS</u>-10 ScrubPAD for stubborn deposits and to reduce cleaning time on the lid and opposing sealing surface
- **Step 9**: Remove the dampened UltraSOLV[®] Wipers from the slit valve. Use a cleaned <u>HT4536DS</u>-10 or an <u>HT4536D</u>-10 ScrubPAD to remove the hardened deposit from the slit valve
- NOTE: See Step 6 for ScrubPAD cleaning procedures. The ScrubPAD can be manipulated for easier cleaning of the surface. Continue to alternate between scrubbing with the ScrubPAD and wiping with the Sponge until yellowish deposit is removed. After scrubbing thoroughly, clean both areas with the Sponge

The slit valve should be cleaned with DI dampened wipers followed by IPA until no contamination is visible on the wiper. Several IPA dampened <u>HT1700</u> swabs should be used to clean the hard-to-reach areas until no contaminant is visible on the swab

Repeat the same process to clean the pump port

Step 10: Immerse the quartz window in DI water for 10-15 minutes and then use the <a href="https://h

AMAT 5500 TxZ CHAMBER PM PROCEDURE (CONT'D):

NOTE: For 12000 wafer PM procedures the cleaning time can be reduced by using the HT4536DS-10 Diamond ScrubPAD to scrub the hard to remove residue from perimeter of the slit valve, lid and view port. For 3000 wafer PM procedures the HT4512DS-10 ScrubPAD may be substituted for the HT4560-10S ScrubPAD

- **Step 11**: To final clean the chamber, lid and sealing surfaces use <u>HT4794</u> wipes. First use 1 to 2 wipers dampened with DI water and then follow with IPA dampened Wipers until there is no contamination left on the wipe
- NOTE: The IPA step should consume 10-12 wipers. To reduce recovery time, use the <u>HT1700</u> and <u>HT1700</u> swabs wetted with IPA to clean the corners, crevices, view port opening and o-ring grooves
- Step 12: Minimize the possibility of system leaks by thoroughly cleaning all o-ring grooves.

 Use IPA dampened (but not saturated) HT1700 swabs to clean o-ring grooves.

 Continue use of HT1700 swabs until contamination is no longer visible on swab.

 Next use IPA dampened HT1714 swabs to clean bottom curved corner surfaces along the entire length of the o-ring groove. Continue use of HT1714 swabs until contamination is no longer visible. Once the o-ring has been inserted, be sure to use an HT4790 or HT4794 wiper with a small amount of IPA to clean the scaling surface

For in-chamber Heater-assembly cleaning, please employ the following steps:

- **Step 13**: Use an <a href="https://example.com/https://example.com
- **NOTE:** As this is a dry procedure, it is not recommended to follow the normal procedure of using a dampened wiper to clean the ScrubPAD
- **Step 14**: Vacuum the perimeter of the heater chuck

As in the above mentioned fashion, delicately clean the roughened surface that runs parallel to the ground with an <u>HT4790</u> or <u>HT4794 Wiper</u>, slightly dampened in IPA, until no visible contamination transfers to the wiper. Due to the rough texture of the surface, it is important to gently pull the wiper across the surface

* As build-up tends to remain trapped in the corner, it is recommended to use 3-5

HT1732">HT1732 swabs, slightly dampened in IPA, to ensure the corner is completely cleaned